

CALL FOR SPEAKERS

SPE Mold Technologies Division

ANTEC® 2027 @ NPE2027

ABSTRACT DEADLINE

October 9, 2026

EVENT

May 3–7, 2027

LOCATION

Orlando, Florida

Share your work with the plastics community.

The SPE Mold Technologies Division invites researchers, engineers, moldmakers, technology suppliers, OEMs, and other industry professionals to submit technical presentation proposals for ANTEC® 2027. Research results, technology developments, industrial case studies, and practical tooling innovations are all welcome.

TOPICS OF INTEREST (includes but not limited to)

- Conformal cooling and advanced mold thermal management
- Additive manufacturing, hybrid tooling, and mold repair
- Hot runners, valve gating, runner systems, and gate technologies
- Precision molding, micro-molding, multi-material, and complex tooling
- Automation, digitalization, and data-driven mold technologies
- Mold design, simulation, optimization, and design-for-manufacturability
- Advanced mold materials, coatings, and surface engineering
- Mold-integrated sensors, cavity sensing, monitoring, and intelligent tooling
- Mold maintenance, diagnostics, predictive maintenance, and tool-life improvement
- Sustainable, energy-efficient, and next-generation tooling technologies

WHY ANTEC® @ NPE2027?

ANTEC® technical programming will be integrated into NPE2027, bringing SPE's technical content directly to the largest plastics trade show in the Americas and a global audience of 51,000+ professionals across the plastics value chain.

SUBMIT YOUR PROPOSAL

Learn more and submit at www.4spe.org/antec27/

DEADLINE

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Questions about whether your topic is a good fit?

Contact Peng Gao gaop@wwu.edu, Technical Program Chair, SPE Mold Technologies Division.